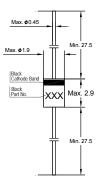
## SILICON EPITAXIAL PLANAR DIODES

Fast Switching Diode



Glass Case DO-34 Dimensions in mm

## Absolute Maximum Ratings (T<sub>a</sub> = 25 °C)

Parameter		Symbol	Value	Unit
Repetitive Peak Reverse Voltage		V <sub>RRM</sub>	75	V
Continuous Reverse Voltage		V <sub>R</sub>	75	V
Continuous Forward Current		١ <sub>F</sub>	200	mA
Repetitive Peak Forward Current		I <sub>FRM</sub>	450	mA
Non-repetitive Peak Forward Current	at t = 1 µs		4	
	at t = 1 ms	I <sub>FSM</sub>	1	А
	at t = 1 s		0.5	
Power Dissipation		P <sub>tot</sub>	500	mW
Junction Temperature		Tj	200	٥C
Storage Temperature Range		Ts	- 65 to + 200	°C

## Characteristics at T<sub>j</sub> = 25 °C

Parameter		Symbol	Max.	Unit
Forward Voltage at I <sub>F</sub> = 10 mA		V <sub>F</sub>	1	V
Reverse Current at $V_R = 20 V$ at $V_R = 50 V$ at $V_R = 20 V$ , $T_j = 150 °C$ at $V_R = 50 V$ , $T_j = 150 °C$	1N4531 1N4532 1N4531 1N4532	I <sub>R</sub> I <sub>R</sub> I <sub>R</sub>	25 100 50 100	nA nA μA μA
Diode Capacitance at f = 1 MHz	1N4531 1N4532	C <sub>d</sub> C <sub>d</sub>	4 2	pF pF
Reverse Recovery Time at $I_F$ = 10 mA, $I_R$ = 60 mA, $R_L$ = 100 $\Omega$ at $I_F$ = 10 mA, $I_R$ = 10 mA, $R_L$ = 100 $\Omega$	1N4531 1N4532 1N4532	t <sub>rr</sub> t <sub>rr</sub> t <sub>rr</sub>	4 2 4	ns ns ns
Forward Recovery Voltage at I <sub>F</sub> = 100 mA, t <sub>r</sub> ≤ 30 ns		V <sub>fr</sub>	3	V
Thermal Resistance from Junction to Ambient		R <sub>thJA</sub>	350	K/W



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